

1500V N-ch High Planar MOSFET

General Features

- **RoHS Compliant**
- $R_{DS(ON),typ.}$ =5.4 Ω @ V_{GS} =10V
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

Applications

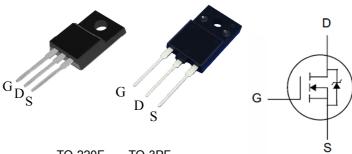
- Adaptor
- Charger
- SMPS Standby Power

Ordering Information

Part Number	Package	Brand
PTH03N150	TO-3PF	ĭ
PTA03N150	TO-220F	ĭ

Lead Free Package and Finish

BV _{DSS}	R _{DS(ON),typ.}	I _D
1500V	5.4Ω	3A



TO-220F TO-3PF

Package No to Scale

Absolute Maximum Ratings

T_C=25°C unless otherwise specified

Symbol	Parameter	PTH03N150	PTA03N150	Unit
V_{DSS}	V _{DSS} Drain-to-Source Voltage 1500		V	
V_{GSS}	Gate-to-Source Voltage	±3	30	V
I _D	Continuous Drain Current	3		А
I _{DM}	Pulsed Drain Current at V _{GS} =10V	12		٨
E _{AS}	Single Pulse Avalanche Energy,L=30mH	500		mJ
P_D	Power Dissipation	90	35	W
ГD	Derating Factor above 25℃	0.72	0.28	W /°C
T _L Soldering Temperature Distance of 1.6mm from case for 10 seconds		300		°C
T _J & T _{STG} Operating and Storage Temperature Range		-55 to	C	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	PTH03N150	PTA03N150	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction-to-Case	1.38	3.57	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	50	100	°CM



Electrical Characteristics

OFF Characteristics

T_J =25 ℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	1500			٧	V _{GS} =0V, I _D =250uA
	1		V _{DS} =1500V, V _{GS} =0V			
I _{DSS}	Drain-to-Source Leakage Current			500	uA	V _{DS} =1200V, V _{GS} =0V, T _J =125℃
1	Cate to Source Leakage Current			+100	nA	V _{GS} =+30V, V _{DS} =0V
I _{GSS}	Gate-to-Source Leakage Current			-100	I IIA	V _{GS} =-30V, V _{DS} =0V

ON Characteristics

T_J =25 ℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
R _{DS(ON)}	Static Drain-to-Source On-Resistance		5.4	8.2	Ω	V _{GS} =10V, I _D =2.0A
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	2.5		4.5	٧	V_{DS} = V_{GS} , I_D =250uA
gfs	Forward Transconductance		3.0		S	V _{DS} =15V,ID=3A

Dynamic Characteristics

Essentially independent of operating temperature

ynamic onaracteristics			indiany in	acpender	t or open	ating temperature
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
C _{iss}	Input Capacitance		1600			\/ -0\/
C_{rss}	Reverse Transfer Capacitance		33		pF	V_{GS} =0V, V_{DS} =25V,
C _{oss}	Output Capacitance		100			f=1.0MH _Z
Rg	Gate input resistance		4.5		Ω	f=1 MHz Gate DC Bias=0 Test signal level=20mV open drain
Q_{g}	Total Gate Charge		36			
Q _{gs}	Gate-to-Source Charge		9.5		nC	V_{DD} =750V, I_{D} =3A, V_{GS} =0 to 10V
Q_{gd}	Gate-to-Drain (Miller) Charge		12			

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
td(ON)	Turn-on Delay Time		25			
trise	Rise Time		48		20	V_{DD} =750V, I_{D} =3A,
td(OFF)	Turn-Off Delay Time		57		nS	V _{GS} =10V Rg=4.7Ω
t fall	Fall Time		52			J



Source-Drain Body Diode Characteristics T_J=25℃ unless otherwise specified

Symbol	Parameter	Min	Тур.	Max.	Unit	Test Conditions
I _{SD}	Continuous Source Current ^[2]			3	۸	Integral pn-diode
I _{SM}	Pulsed Source Current ^[2]			12	Α	in MOSFET
V _{SD}	Diode Forward Voltage			1.5	V	I _S =3A, V _{GS} =0V
trr	Reverse Recovery Time		255		ns	V _{GS} =0V
Qrr	Reverse Recovery Charge		1.1		uC	I⊧=3A, di/dt=100A/µs

Note:

^[1] T_J=+25 $^{\circ}$ C to +150 $^{\circ}$ C

^[2] Pulse width≤380µs; duty cycle≤2%.



Typical Characteristics

Figure 1. Maximum Transient Thermal Impedance

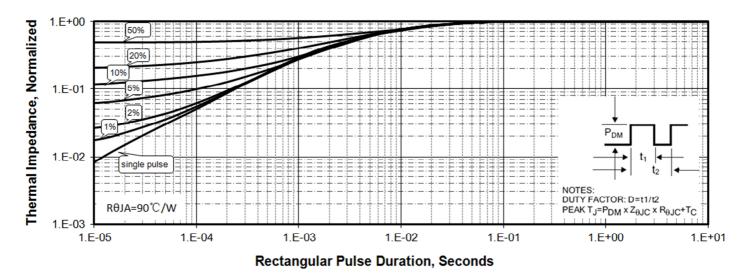


Figure 2. Max. Power Dissipation vs Case Temperature

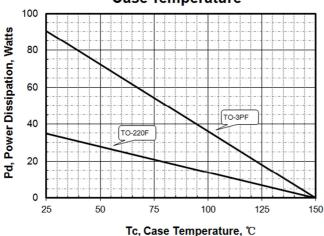


Figure 4. Output Characteristics

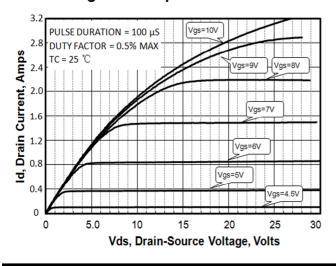


Figure 3 .Maximum Continuous Drain
Current vs Tc

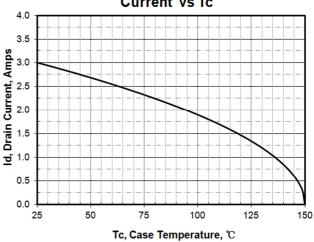
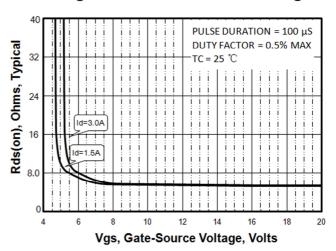


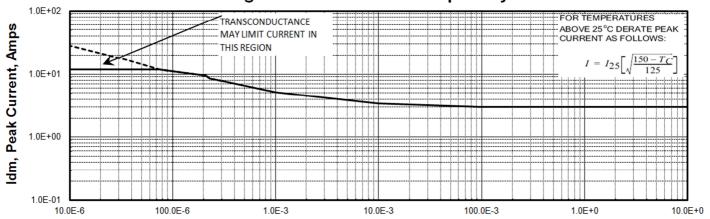
Figure 5. Rdson vs Gate Voltage





Typical Characteristics(Cont.)





t, Pulse Width, Seconds

Figure 7. Transfer Characteristics

d, Drain to Source Current, Amps PULSE DURATION = 10 μS DUTY FACTOR = 0.5% MAX +25°C 4.8 3.6 1.2 0 3.0

Figure 9. Drain to Source ON Resistance vs Drain Current

Vgs, Gate to Source Voltage, Volts

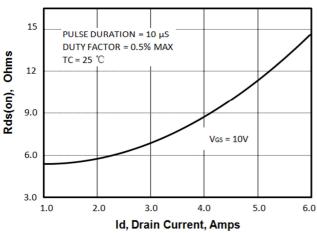


Figure 8. Unclamped Inductive Switching Capability

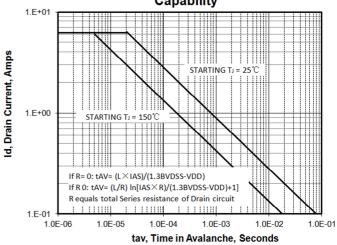
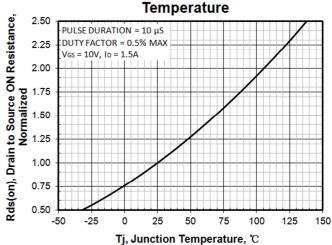
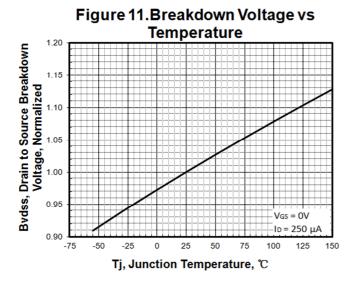


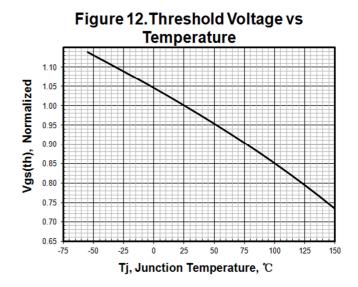
Figure 10. Rdson vs Junction

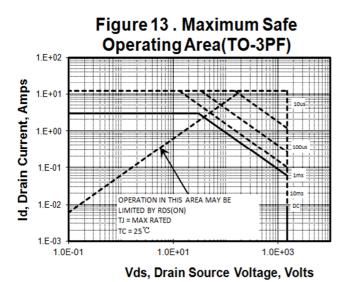




Typical Characteristics (Cont.)







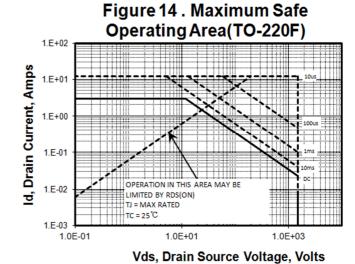
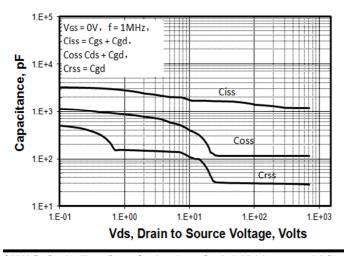
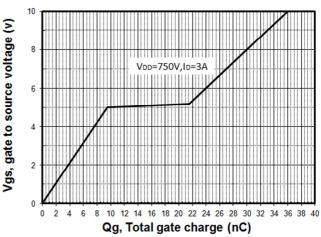


Figure 15. Capacitance vs Vds









Test Circuits and Waveforms

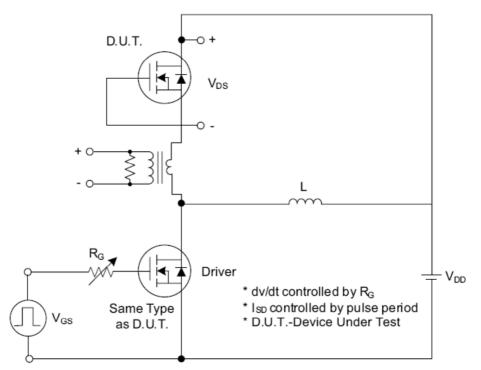


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

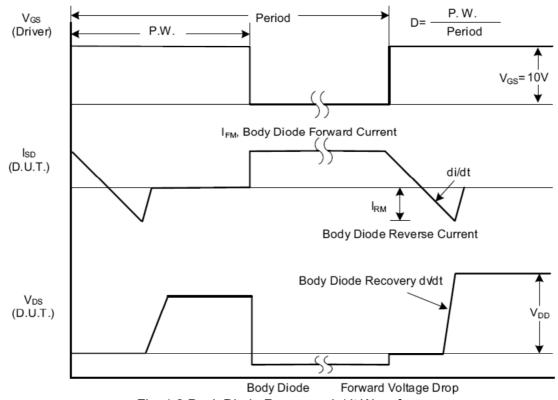


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms



Test Circuits and Waveforms (Cont.)

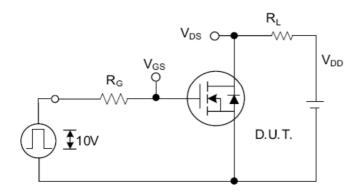


Fig. 2.1 Switching Test Circuit

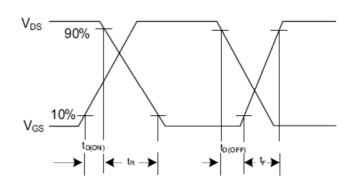


Fig. 2.2 Switching Waveforms

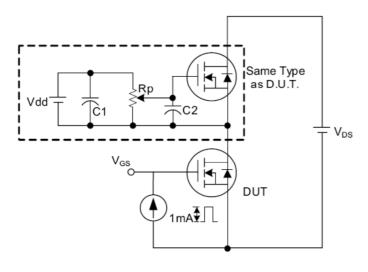


Fig. 3 . 1 Gate Charge Test Circuit

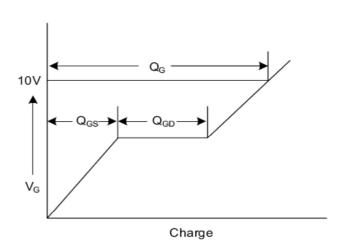


Fig. 3.2 Gate Charge Waveform

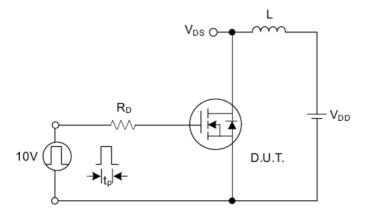


Fig. 4.1 Unclamped Inductive Switching Test Circuit

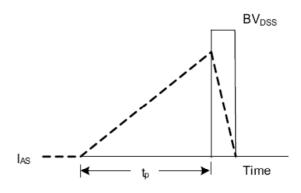


Fig. 4.2 Unclamped Inductive Switching Waveforms



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